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APPLICATION N	0.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/013,103		11/06/2001	Krishna Seshan	42390P5778D	1577
8791	7590 03/31/2006			EXAMINER	
		LOFF TAYLOR & DULEVARD	LEWIS, N	LEWIS, MONICA	
	H FLOOR	JOLE VAICE	ART UNIT	PAPER NUMBER	
LOS ANO	GELES, CA	90025-1030		2822	

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application No.	Applicant(s)				
•		10/013,103	SESHAN ET AL.				
	Office Action Summary	Examiner	Art Unit				
		Monica Lewis	2822				
	The MAILING DATE of this communication app	ears on the cover sheet with the c	orrespondence address				
Period fo	• •						
WHIC - Exter after - If NC - Failu Any	ORTENED STATUTORY PERIOD FOR REPLY CHEVER IS LONGER, FROM THE MAILING DATE is not soft time may be available under the provisions of 37 CFR 1.13 SIX (6) MONTHS from the mailing date of this communication. Period for reply is specified above, the maximum statutory period were to reply within the set or extended period for reply will, by statute, reply received by the Office later than three months after the mailing and patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tim vill apply and will expire SIX (6) MONTHS from 1, cause the application to become ABANDONE	N. nely filed the mailing date of this communication. D (35 U.S.C. § 133).				
Status		•					
1)	Responsive to communication(s) filed on <u>17 Ja</u>	anuary 2006					
,—	·	action is non-final.					
3)□	•—		secution as to the merits is				
الــار	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.						
	in addordance with the precise and a	x parto quayro, roco c.b. 11, 10					
Dispositi	on of Claims	•					
4)⊠	Claim(s) 17-23 and 25-29 is/are pending in the	application.	**				
	4a) Of the above claim(s) 23,25 and 26 is/are withdrawn from consideration.						
5)	Claim(s) is/are allowed.						
6)⊠	Claim(s) <u>17-22 and 27-29</u> is/are rejected.						
7)	Claim(s) is/are objected to.		•				
8)[	Claim(s) are subject to restriction and/or	r election requirement.					
Applicati	on Papers						
9) The specification is objected to by the Examiner.							
10)⊠ The drawing(s) filed on <u>12 September 2002</u> is/are: a)⊠ accepted or b)□ objected to by the Examiner.							
, , ,	Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).						
	Replacement drawing sheet(s) including the correct	- · ·					
11)[T	The oath or declaration is objected to by the Ex						
_	ınder 35 U.S.C. § 119		•				
•	Acknowledgment is made of a claim for foreign	priority under 35 U.S.C. § 119(a)	-(d) or (f).				
a)	⊠ All b) Some * c) None of:						
•	1. Certified copies of the priority documents						
	2. Certified copies of the priority documents						
	3. Copies of the certified copies of the prior		ed in this National Stage				
	application from the International Bureau						
* 5	see the attached detailed Office action for a list	of the certified copies not receive	d.				
		•					
		•					
Attachmen	t(s)	•					
	e of References Cited (PTO-892)	4) Interview Summary					
2) Notice of Draftsperson's Patent Drawing Review (PTO-948) Paper No(s)/Mail Date							
	nation Disclosure Statement(s) (PTO-1449 or PTO/SB/08) r No(s)/Mail Date	5)  Notice of Informal P	atent Application (PTO-152)				
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Art Unit: 2822

#### **DETAILED ACTION**

1. This action is in response to the amendment filed January 17, 2006.

### Specification

2. The lengthy specification has not been checked to the extent necessary to determine the presence of all possible minor errors. Applicant's cooperation is requested in correcting any errors of which applicant may become aware in the specification.

## Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. Claim 27 is rejected under 35 U.S.C. 102(e) as anticipated by or, in the alternative, under 35 U.S.C. 103(a) as obvious over Cox (U.S. Patent No. 6,166,439).

In regards to claim 27, Cox discloses the following:

- a) a substrate (50b) (For Example: See Figure 4H);
- b) an insulating layer (50a) formed directly on the substrate (For Example: See Figure 4H);
- c) at least one bond pad (54) formed directly on the insulating layer (For Example: See Figure 4H);
  - d) a first layer (61) (For Example: See Figure 4H);
- e) the first layer is disposed between the insulating layer and the second layer (59) (For Example: See Figure 4H);
- f) the first layer and the second layer comprise one common chemical element other than silicon (For Example: See Column 7 Lines 44-46 and Column 8 Lines 12-16); and

Art Unit: 2822

g) the second layer is a passivation layer formed on the first layer and a portion of a surface of the bond pad that is less than the entire surface (For Example: See Figure 4H).

Finally, the following limitation makes it a product by process claim: a) "formed from a modification of a portion of the insulating layer." The MPEP § 2113, states, "Even though product -by[-] process claims are limited by and defined by the process, determination of patentability is based upon the product itself. The patentability of a product does not depend on its method of production. If the product in product-by-process claim is the same as or obvious from a product of the prior art, the claim is unpatentable even though the prior product is made by a different process." *In re Thorpe*, 227 USPQ 964, 966 (Fed. Cir. 1985)(citations omitted).

A "product by process" claim is directed to the product per se, no matter how actually made, In re Hirao and Sato et al., 190 USPQ 15 at 17 (CCPA 1976) (footnote 3). See also In re Brown and Saffer, 173 USPQ 685 (CCPA 1972): In re Luck and Gainer, 177 USPQ 523 (CCPA 1973); In re Fessmann, 180 USPQ 324 (CCPA 1974); and In re Marosi et al., 218 USPQ 289 (CAFC 1983) final product per se which must be determined in a "product by, all of" claim, and not the patentability of the process, and that an old or obvious product, whether claimed in "product by process" claims or not. Note that Applicant has the burden of proof in such cases, as the above caselaw makes clear.

5. Claims 17-19, 21 and 22 are rejected under 35 U.S.C. 103(a) as obvious over Cox (U.S. Patent No. 6,166,439) in view of Applicant's Prior Art.

In regards to claim 17, Cox discloses the following:

- a) a substrate (50b) comprising at least one level of interconnection (For Example: See Figure 4H);
- b) an insulating layer (50a) formed directly on a surface of the substrate (For Example: See Figure 4H);

Art Unit: 2822

c) at least one bond pad (54) formed directly on the insulating layer, the at least one bond pad coupled through the insulating layer to the at least one level of interconnection of the substrate (For Example: See Figure 4H);

- d) an adhesion layer (61) formed on a surface of the insulating layer such that the insulating layer is disposed between the adhesion layer and the substrate (For Example: See Figure 4H); and
- e) a passivation layer (59) formed on a surface of said adhesion layer and a portion of a surface of the bond pad that is less than the entire surface (For Example: See Figure 4H).

In regards to claim 17, Cox fails to disclose the following:

a) a first passivation layer formed on a top surface of the conductive structure.

However, Applicant's Prior Art discloses a semiconductor device that has a first passivation layer (40) formed on a top surface of the conductive structure (33) (For Example: See Figure 6). It would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the semiconductor of Cox to include a first passivation layer formed on a top surface of the conductive structure as disclosed in Applicant's Prior Art because it aids in protecting the device from scratches, moisture and impurities (For Example: See Page 10 Lines 9 and 10).

Additionally, since Cox and Applicant's Prior Art are both from the same field of endeavor, the purpose disclosed by Applicant's Prior Art would have been recognized in the pertinent art of Cox.

In regards to claim 18, Cox fails to disclose the following:

a) the passivation layer is a first passivation layer, the integrated circuit further comprising a second passivation layer formed upon said first passivation layer.

However, Applicant's Prior Art discloses a semiconductor device that has a second passivation layer (45) formed upon said first passivation layer (40) (For Example: See Figure 6).

Art Unit: 2822

It would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the semiconductor of Cox to include a second passivation layer formed upon said first passivation layer as disclosed in Applicant's Prior Art because it aids in protecting the device from scratches, moisture and impurities (For Example: See Page 10 Lines 9 and 10).

Additionally, since Cox and Applicant's Prior Art are both from the same field of endeavor, the purpose disclosed by Applicant's Prior Art would have been recognized in the pertinent art of Cox.

In regards to claim 19, Cox discloses the following:

a) oxide layer includes silicon dioxide  $(Si0_2)$  (For Example: See Page 5 Lines 1-7).

In regards to claim 21, Cox fails to disclose the following:

a) first passivation layer includes silicon nitride (Si<sub>3</sub>N<sub>4</sub>).

However, Applicant's Prior Art discloses a semiconductor device that has a first passivation layer (40) that includes silicon nitride (Si<sub>3</sub>N<sub>4</sub>) (For Example: See Figure 6 and Page 10 Line 15). It would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the semiconductor of Cox to include a semiconductor device that has a first passivation layer that includes silicon nitride as disclosed in Applicant's Prior Art because it aids in protecting the device from scratches, moisture and impurities (For Example: See Page 10 Lines 9 and 10).

Additionally, since Cox and Applicant's Prior Art are both from the same field of endeavor, the purpose disclosed by Applicant's Prior Art would have been recognized in the pertinent art of Cox.

Art Unit: 2822

In regards to claim 22, Cox fails to disclose the following:

a) second passivation layer includes polyimide.

However, Applicant's Prior Art discloses a semiconductor device that has a second passivation layer (45) that includes polyimide (For Example: See Figure 6 and Page 10 Line 16). It would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the semiconductor of Cox to include a semiconductor device that has a second passivation layer that includes polyimide as disclosed in Applicant's Prior Art because it aids in protecting the device from scratches, moisture and impurities (For Example: See Page 10 Lines 9 and 10).

Additionally, since Cox and Applicant's Prior Art are both from the same field of endeavor, the purpose disclosed by Applicant's Prior Art would have been recognized in the pertinent art of Cox.

6. Claim 20 is rejected under 35 U.S.C. 103(a) as obvious over Cox (U.S. Patent No. 6,166,439) in view of Applicant's Prior Art and Dass et al. (U.S. Patent No. 6,046,101).

In regards to claim 20, Cox fails to disclose the following:

a) adhesion layer includes silicon oxynitride.

However, Dass et al. ("Dass") discloses a semiconductor device that has an adhesion layer that includes silicon oxynitride (For Example: See Column 7 Line 19). It would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the semiconductor of Cox to include a semiconductor device that has an adhesion layer that includes silicon oxynitride as disclosed in Dass because it aids in protecting the conductive structure from contamination (For Example: See Page 7 Lines 59-63).

Art Unit: 2822

Additionally, since Cox and Dass are both from the same field of endeavor, the purpose disclosed by Dass would have been recognized in the pertinent art of Cox.

7. Claim 28 is rejected under 35 U.S.C. 103(a) as obvious over Cox (U.S. Patent No. 6,166,439) in view of Dass et al. (U.S. Patent No. 6,046,101).

In regards to claim 28, Cox fails to disclose the following:

a) the first layer includes silicon oxynitride.

However, Dass discloses a semiconductor device that has a first layer that includes silicon oxynitride (For Example: See Column 7 Line 19). It would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the semiconductor of Cox to include a semiconductor device that has a first layer that includes silicon oxynitride as disclosed in Dass because it aids in protecting the conductive structure from contamination (For Example: See Page 7 Lines 59-63).

Additionally, since Cox and Dass are both from the same field of endeavor, the purpose disclosed by Dass would have been recognized in the pertinent art of Cox.

8. Claim 29 is rejected under 35 U.S.C. 103(a) as obvious over Cox (U.S. Patent No. 6,166,439) in view of Dass et al. (U.S. Patent No. 6,046,101) and Applicant's Prior Art.

In regards to claim 29, Cox fails to disclose the following:

a) second layer includes silicon nitride (Si<sub>3</sub>N<sub>4</sub>).

However, Applicant's Prior Art discloses a semiconductor device that has a second layer (40) that includes silicon nitride (Si<sub>3</sub>N<sub>4</sub>) (For Example: See Figure 6 and Page 10 Line 15). It would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the semiconductor of Cox to include a semiconductor device that has a second

Art Unit: 2822

layer that includes silicon nitride as disclosed in Applicant's Prior Art because it aids in protecting the device from scratches, moisture and impurities (For Example: See Page 10 Lines 9 and 10).

Additionally, since Cox and Applicant's Prior Art are both from the same field of endeavor, the purpose disclosed by Applicant's Prior Art would have been recognized in the pertinent art of Cox.

### Response to Arguments

9. Applicant's arguments filed 1/17/06 have been fully considered but they are not persuasive. First, Applicant argues that Cox fails to disclose that "the second layer is a passivation layer formed on the first layer and a portion of a surface of the bond pad that is less than the entire surface...Claim 27 describes a bond pad of a circuit structure and a composite film including a second layer formed on a portion of a surface of a bond pad. Cox is describing interlayer dielectrics, not passivation layers associated with bond pads." However, Cox discloses a second layer (59) that is a passivation layer formed on the first layer (61) and a portion of a surface of the bond pad (54) that is less than the entire surface (For Example: See Figure 4H).

Second, Applicant argues that there "is no motivation to combine Cox and APA...One purpose of the passivation layer in Claim 17 is to protect the circuit structure...Cox, on the other hand, is directed to insulating interconnect lines with a high dielectric constant material." In response to applicant's argument that there is no suggestion to combine the references, the examiner recognizes that obviousness can only be established by combining or modifying the teachings of the prior art to produce the claimed invention where there is some teaching, suggestion, or motivation to do so found either in the references themselves or in the knowledge

Art Unit: 2822

generally available to one of ordinary skill in the art. See *In re Fine*, 837 F.2d 1071, 5

USPQ2d 1596 (Fed. Cir. 1988)and *In re Jones*, 958 F.2d 347, 21 USPQ2d 1941 (Fed. Cir. 1992). In this case, it would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the semiconductor of Cox to include a first passivation layer formed on a top surface of the conductive structure as disclosed in Applicant's Prior Art because it aids in protecting the device from scratches, moisture and impurities (For Example: See Page 10 Lines 9 and 10). Additionally, the fact that applicant has recognized another advantage which would flow naturally from following the suggestion of the prior art cannot be the basis for patentability when the differences would otherwise be obvious. See *Ex parte Obiaya*, 227 USPQ 58, 60 (Bd. Pat. App. & Inter. 1985).

#### Conclusion

10. THIS ACTION IS MADE FINAL. Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

Application/Control Number: 10/013,103 Page 10

Art Unit: 2822

11. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Monica Lewis whose telephone number is 571-272-1838. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Zandra Smith can be reached on 571-272-2429. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300 for regular and after final communications.

ML March 22, 2006

> Mary Wilczewski Primary Examiner